

Features

- Saturated Power: 9 W
- Drain Efficiency: 55 %
- Small Signal Gain: 14 dB
- Lead-Free Air Cavity Ceramic Package
- RoHS* Compliant

Applications

- Avionics - TACAN, DME, IFF
- Military Radio
- L, S, C-Band Radar
- Electronic Warfare
- ISM
- General Amplification

Description

The MAPC-A3005-AS is a 9 W packaged, unmatched transistor utilizing a high performance, 0.15 μm GaN on SiC production process. This transistor supports both defense and commercial related applications.

Offered in a thermally-enhanced flange package, the MAPC-A3005-AS provides superior performance under CW operation allowing customers to improve SWaP-C benchmarks in their next generation systems.

Typical RF Performance:

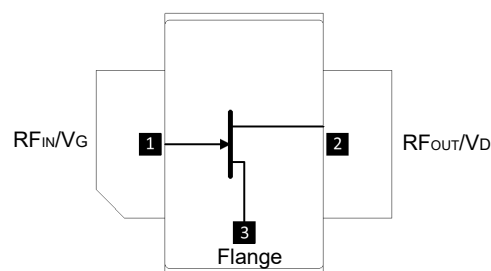
- Measured at CW , $P_{IN} = 30 \text{ dBm}$, $V_{DS} = 28 \text{ V}$, $I_{DQ} = 100 \text{ mA}$, $T_C = 25^\circ\text{C}$

Frequency (GHz)	Output Power (dBm)	Gain (dB)	η_D (%)
2	40.0	10.0	68.6
4	40.4	10.4	58.2
6	39.2	9.2	52.3



440109

Functional Schematic



Pin Configuration

Pin #	Pin Name	Function
1	RF_{IN} / V_G	RF Input / Gate
2	RF_{OUT} / V_D	RF Output / Drain
3	Flange ³	Ground / Source

1. The flange on the package bottom must be connected to RF, DC and thermal ground.

Ordering Information

Part Number	MOQ Increment
MAPC-A3005-AS000	Bulk Quantity: Earless
MAPC-A3005-ASSB1	Sample Board : Earless

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

**Electrical Specifications: Frequency = 2 GHz, $T_A = +25^\circ\text{C}$, $V_{DD} = 28\text{ V}$, $I_{DQ} = 100\text{ mA}$,
Low Power Gain tested at Input Power of 10 dBm.**

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Units
Saturated Power	$P_{IN} = 30\text{ dBm}$, CW	P_{SAT}	8.7	9.5	-	W
Drain Efficiency	$P_{IN} = 30\text{ dBm}$, CW	η_{SAT}	59	66	-	%
Low Power Gain	$P_{IN} = 10\text{ dBm}$, CW	G_{SS}	12.0	14.5	-	dB

Note: Final testing and screening for all transistor sales is performed using the MAPC-A3005-AS-AMP at 2 GHz.

Absolute Maximum Ratings^{2,3}

Parameter	Absolute Maximum
Drain-Source Voltage	84 V
Gate Voltage	-10, +2 V
Drain Current	0.75 A
Gate Current	2.16 mA
Input Power	31 dBm
Storage Temperature	-55°C to $+150^\circ\text{C}$
Mounting Temperature	$+245^\circ\text{C}$
Junction Temperature ^{3,4,5}	$+225^\circ\text{C}$
Operating Temperature	-40°C to $+85^\circ\text{C}$

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- MACOM does not recommend sustained operation near these survivability limits.
- Operating at nominal conditions with $T_J \leq +225^\circ\text{C}$ will ensure $MTTF > 1 \times 10^6$ hours.
- Junction Temperature (T_J) = $T_C + \Theta_{jc} * (V * I)$
Typical thermal resistance (Θ_{jc}) = 9.5°C/W for CW.
 - For $T_C = +25^\circ\text{C}$,
 $T_J = 78^\circ\text{C}$ @ $P_{DISS} = 5.6\text{ W}$
 - For $T_C = +85^\circ\text{C}$,
 $T_J = 137^\circ\text{C}$ @ $P_{DISS} = 5.4\text{ W}$

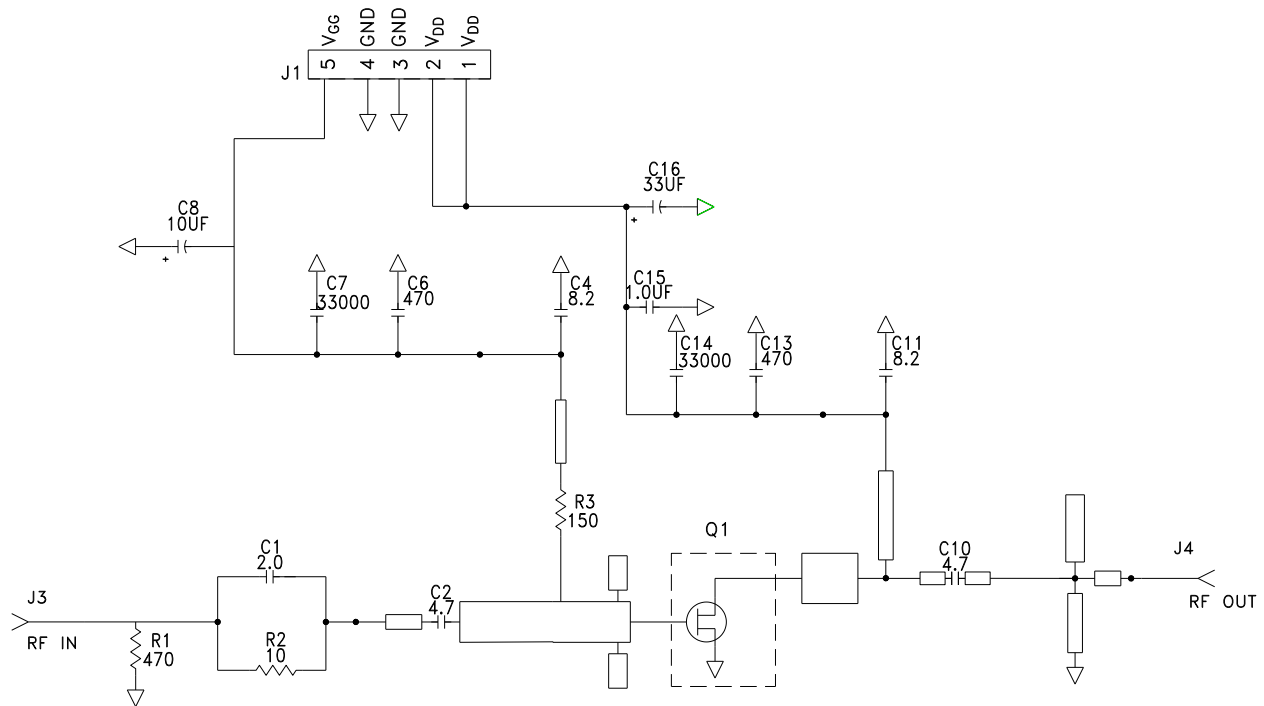
Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

Evaluation Test Fixture and Recommended Tuning Solution, 2 GHz



Biasing Sequence

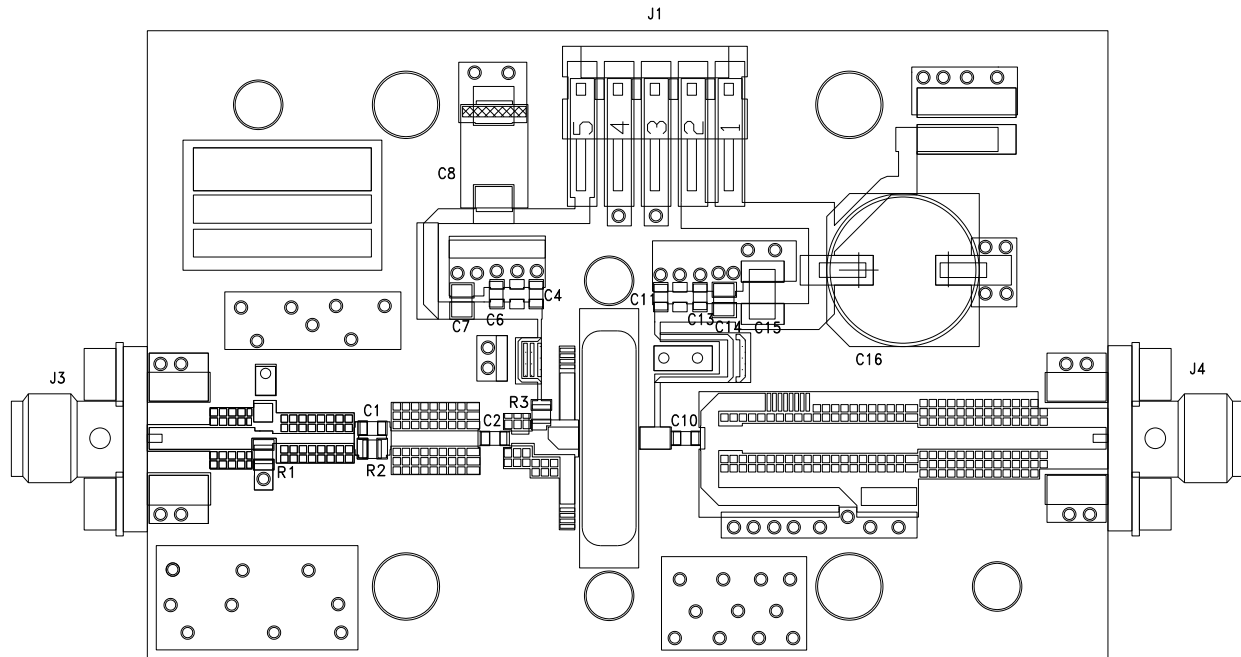
Bias ON

1. Ensure RF is turned off
2. Apply pinch-off voltage of -5 V to the gate
3. Apply nominal drain voltage
4. Bias gate to desired quiescent drain current
5. Apply RF

Bias OFF

1. Turn RF off
2. Apply pinch-off voltage of -5 V to the gate
3. Turn-off drain voltage
4. Turn-off gate voltage

Evaluation Test Fixture and Recommended Tuning Solution, 2 GHz



Assembly Parts List

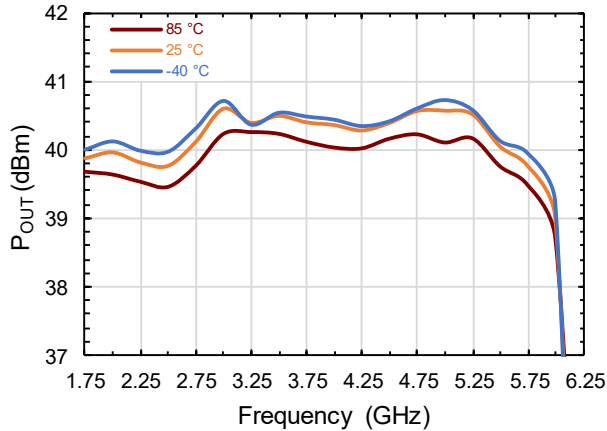
Designator	Description	Qty.
C1	CAP, 2 pF, +/-0.1, 250V, 0603, 125C, ATC 600S	1
C2, C10	CAP, 4.7 pF, +/-0.1, 250V, 0603, 125C, ATC 600S	2
C4, C11	CAP, 8.2 pF, +/-0.1, 250V, 0603, 125C, ATC 600S	2
C6, C13	CAP, 470 pF, +/-T5%, 0603in, 100V, 125c Murata	2
C7, C14	CAP, 0.033 μ F, +/-T10%, 100V, 0805in, 125C Murata	2
C8	CAP, 10 μ F, +/-T20%, 16V, 2312in, 125C, AVX	1
C15	CAP, 1 μ F, +/-T10%, 63V, 1210in, 125C, Murata	1
C16	CAP, 33 μ F, +/-T20%, 100V, CAN-SMD, 105C, Panasonic	1
R1	RES, 25 W, 0505, 5%, 470 Ω , 150C	1
R2	RES, 25 W, 0505, 5%, 10 Ω , 150C	1
R3	RES, 25 W, 0505, 5%, 150 Ω , 150C	1
J1	HEADER RT>PLZ .1CEN LK 5POS	1
J3,J4	CONNECTOR; SMB, Straight, JACK, SMD	2
-	PCB, RO5880, Er = 2.20, H = 20 mil	1
Q1	MAPC-A3005-AS	1

Typical Performance Curves as Measured in the 2 - 6 GHz Evaluation Test Fixture

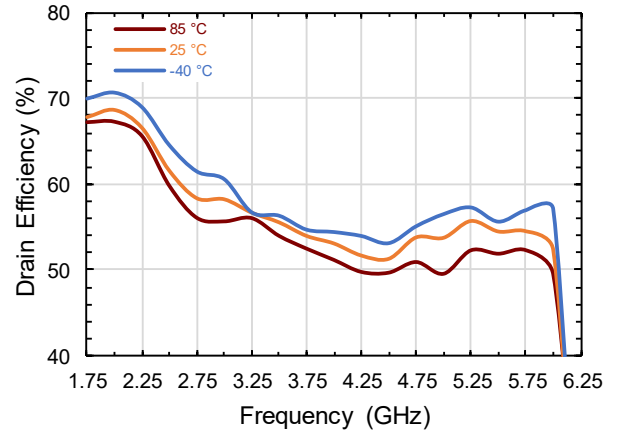
CW, $P_{IN} = 30$ dBm, $V_{DS} = 28$ V, $I_{DQ} = 100$ mA. Frequency = 4 GHz (unless otherwise noted)

For Engineering Evaluation Only – This data does not Modify MACOM's Datasheet Limits.

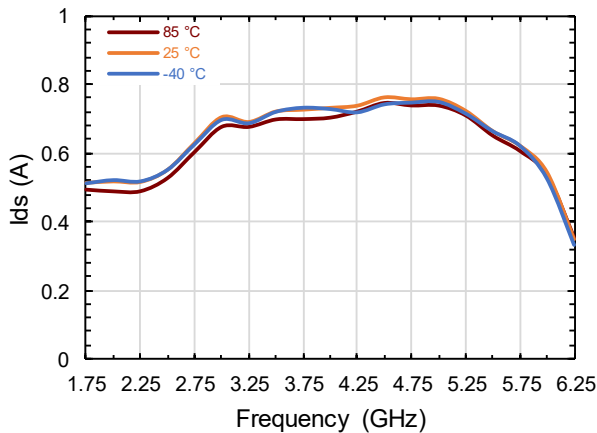
Output Power vs. Temperature and Frequency



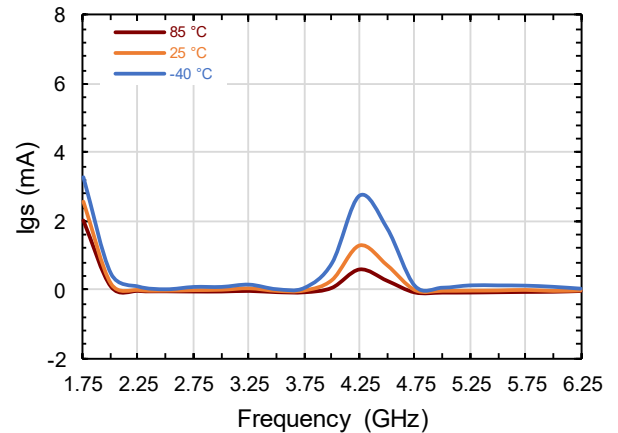
Drain Efficiency vs. Temperature and Frequency



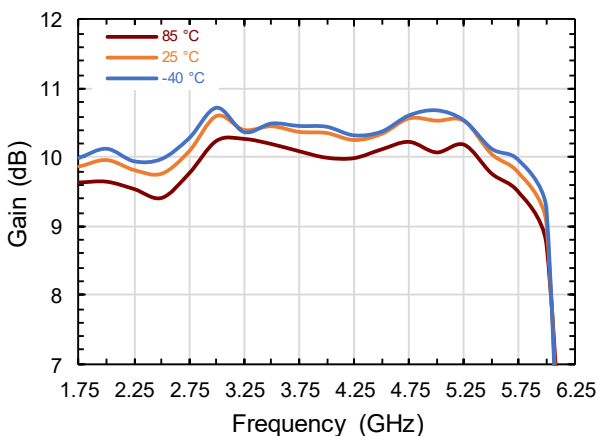
Drain Current vs. Temperature and Frequency



Gate Current vs. Temperature and Frequency



Large Signal Gain vs. Temperature and Frequency

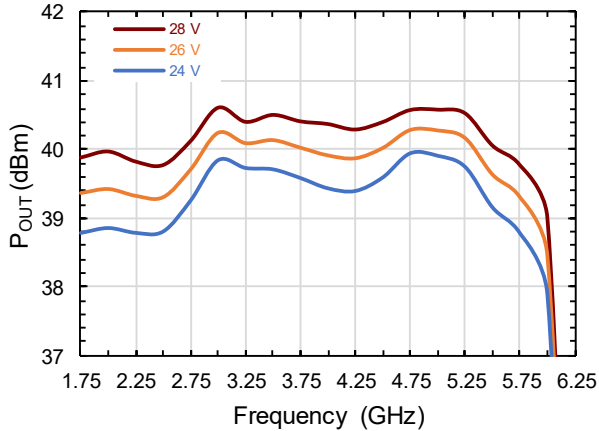


Typical Performance Curves as Measured in the 2 - 6 GHz Evaluation Test Fixture

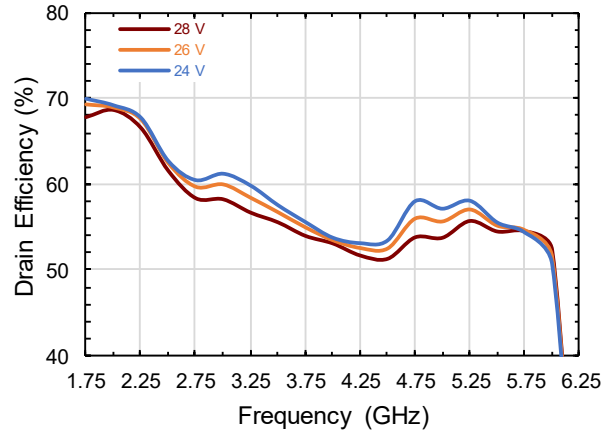
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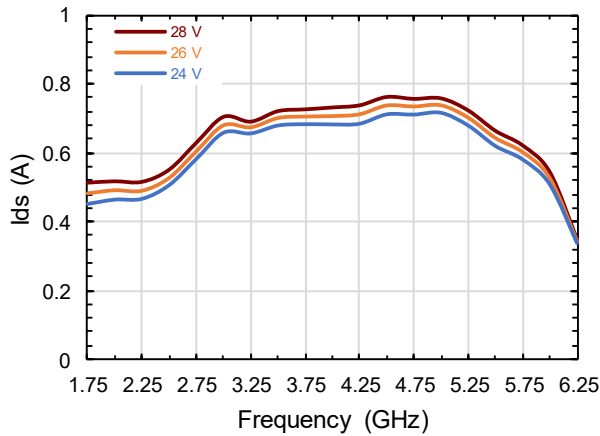
Output Power vs. V_{DS} and Frequency



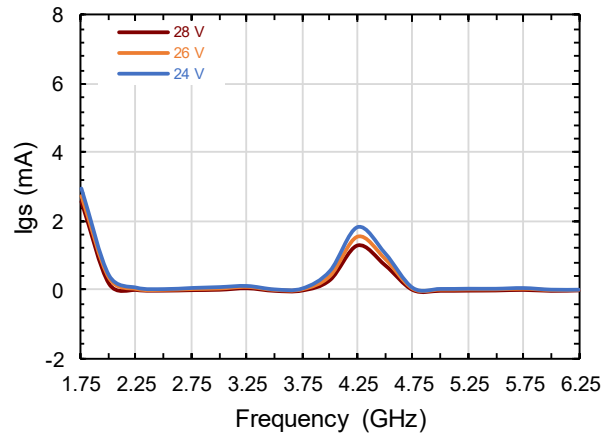
Drain Efficiency vs. V_{DS} and Frequency



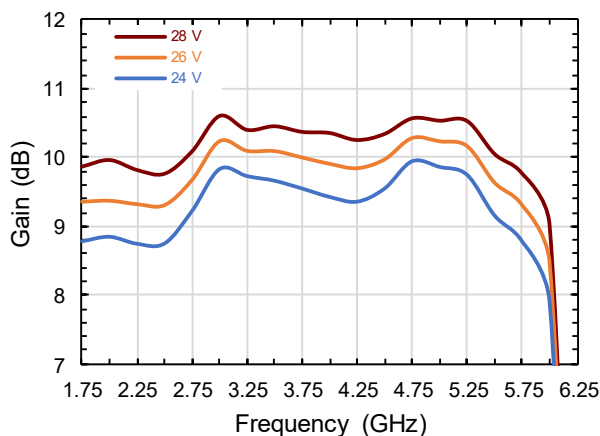
Drain Current vs. V_{DS} and Frequency



Gate Current vs. V_{DS} and Frequency



Large Signal Gain vs. V_{DS} and Frequency

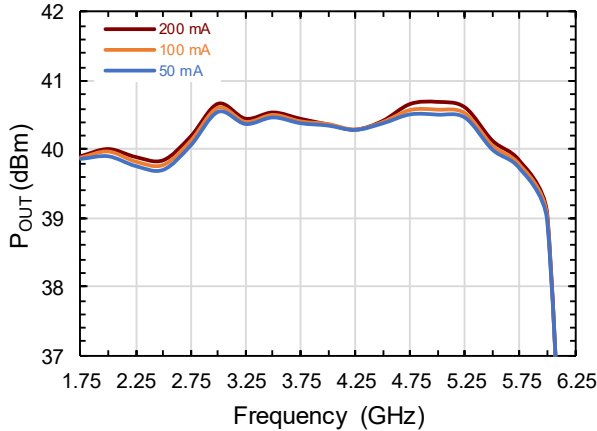


Typical Performance Curves as Measured in the 2 - 6 GHz Evaluation Test Fixture

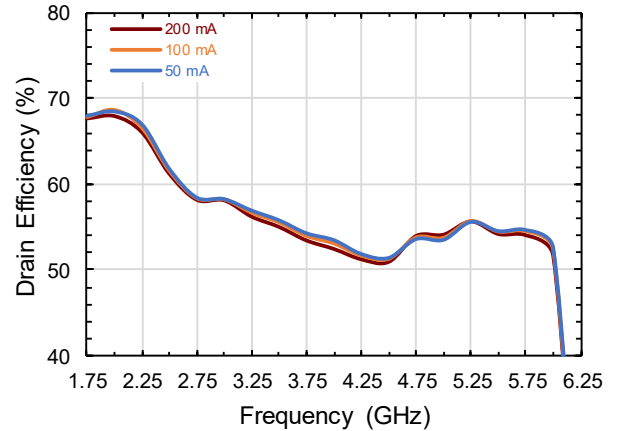
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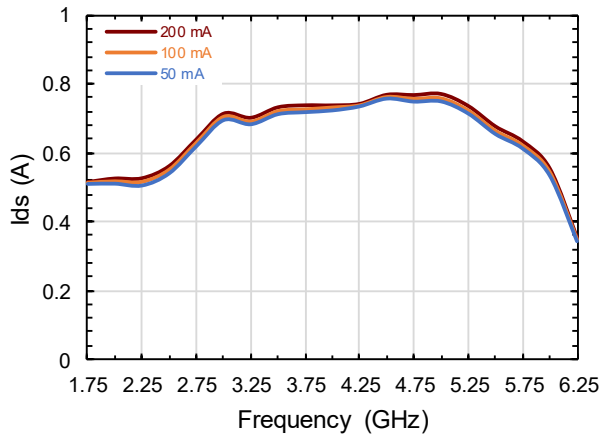
Output Power vs. I_{DQ} and Frequency



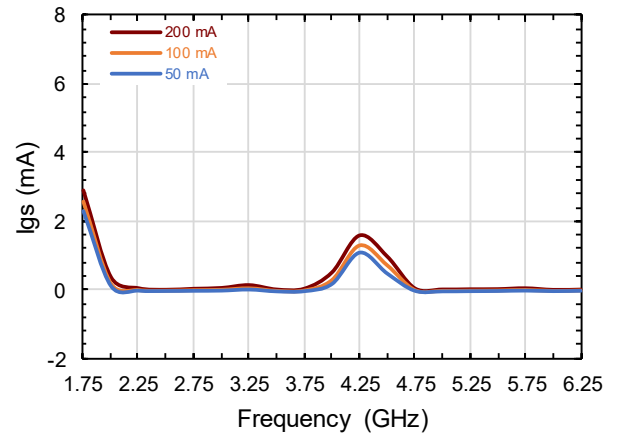
Drain Efficiency vs. I_{DQ} and Frequency



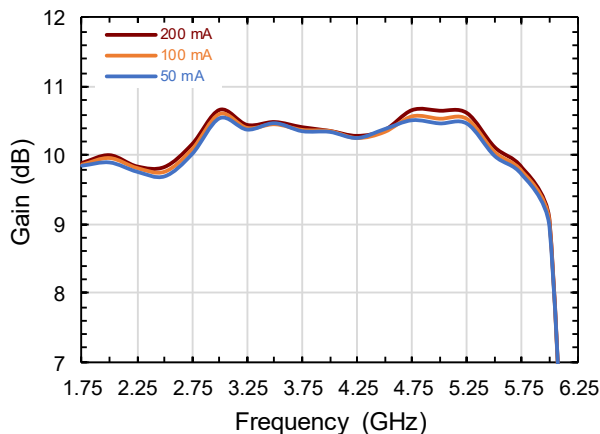
Drain Current vs. I_{DQ} and Frequency



Gate Current vs. I_{DQ} and Frequency



Large Signal Gain vs. I_{DQ} and Frequency

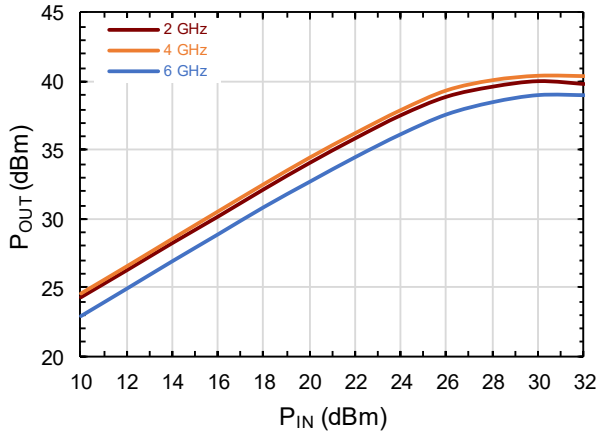


Typical Performance Curves as Measured in the 2 - 6 GHz Evaluation Test Fixture

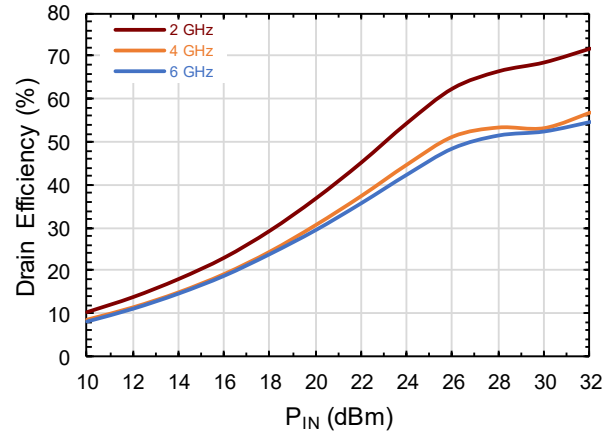
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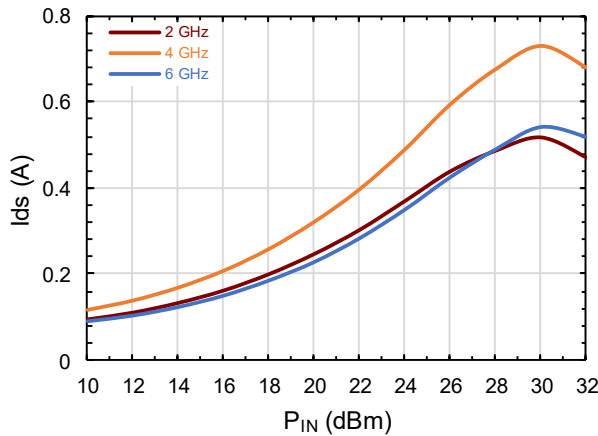
Output Power vs. Frequency and P_{IN}



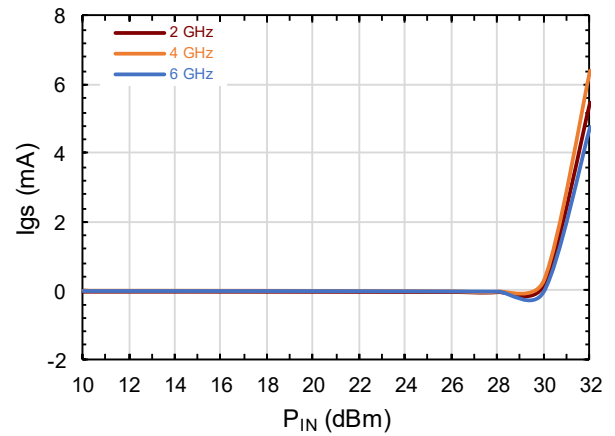
Drain Efficiency vs. Frequency and P_{IN}



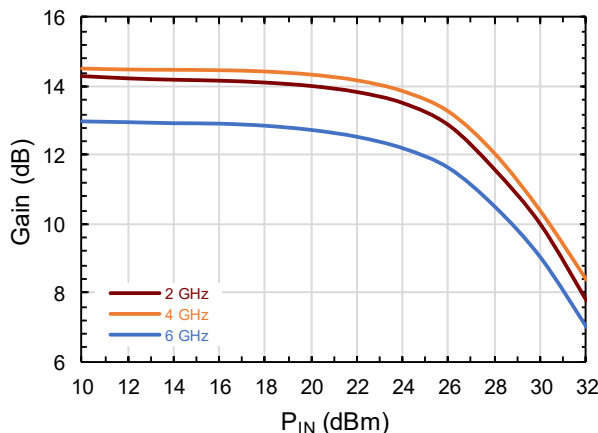
Drain Current vs. Frequency and P_{IN}



Gate Current vs. Frequency and P_{IN}



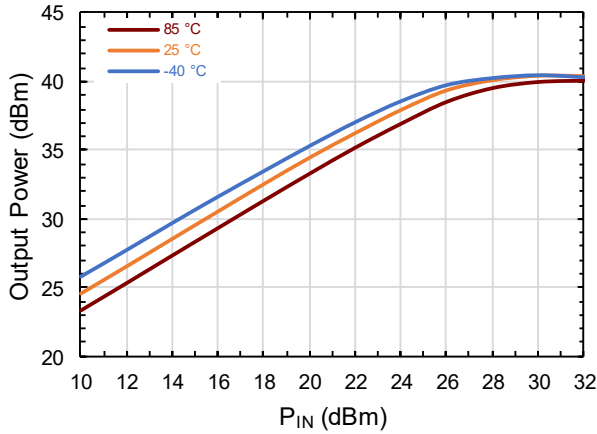
Large Signal Gain vs. Frequency and P_{IN}



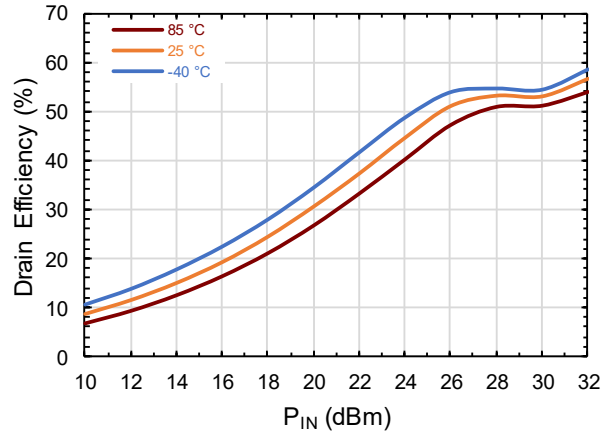
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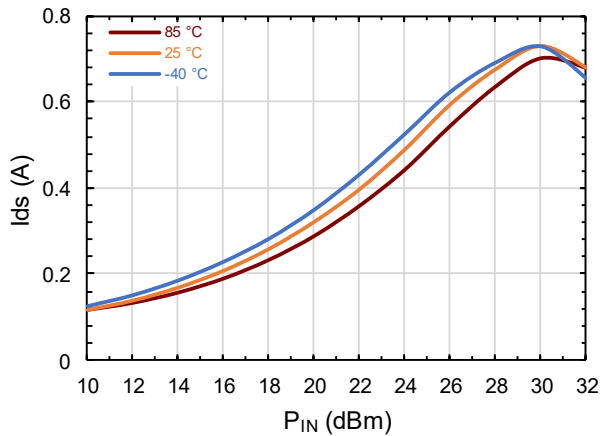
Output Power vs. Temperature and P_{IN}



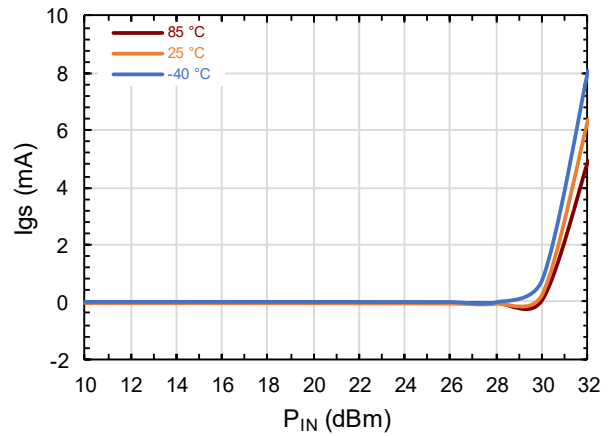
Drain Efficiency vs. Temperature and P_{IN}



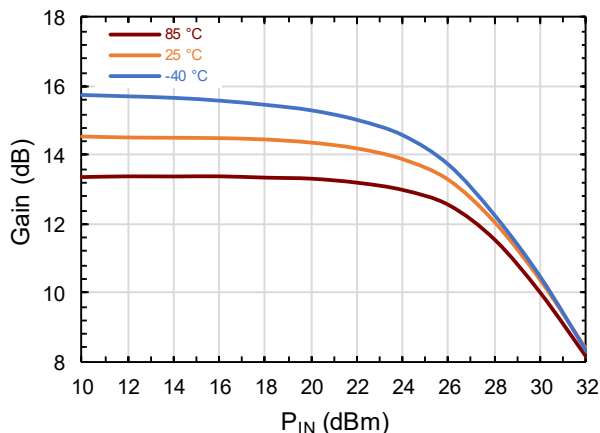
Drain Current vs. Temperature and P_{IN}



Gate Current vs. Temperature and P_{IN}



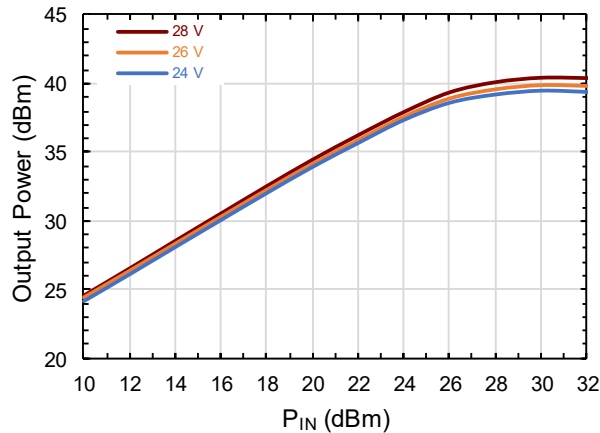
Large Signal Gain vs. Temperature and P_{IN}



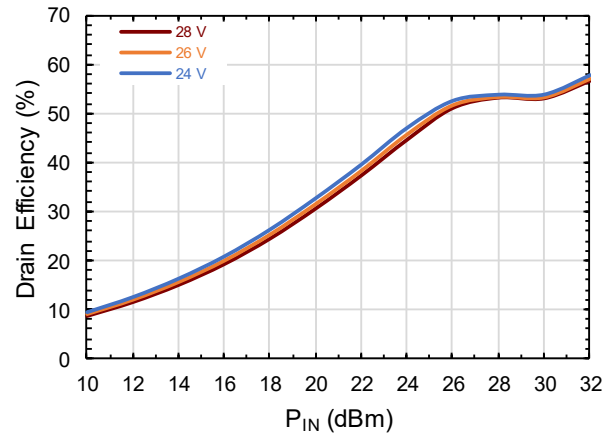
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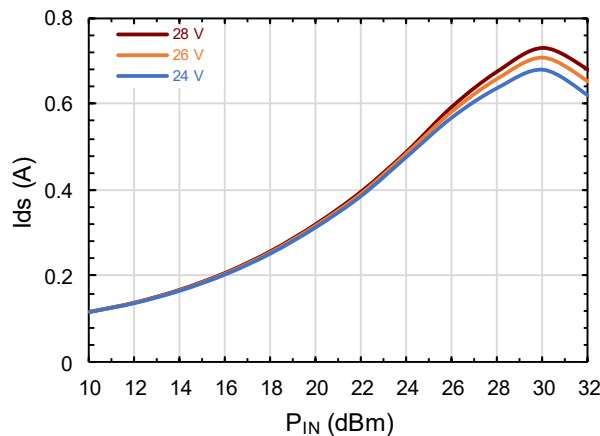
Output Power vs. V_{DS} and P_{IN}



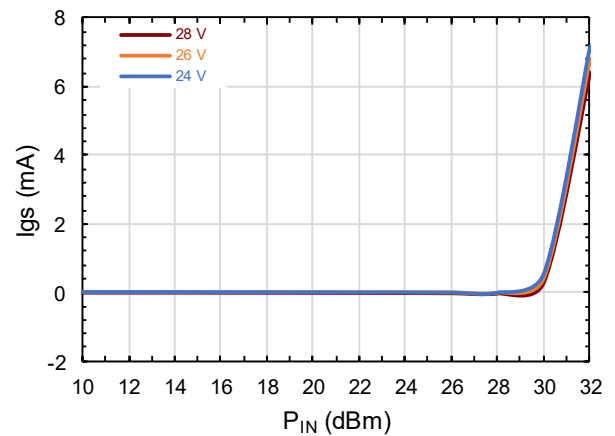
Drain Efficiency vs. V_{DS} and P_{IN}



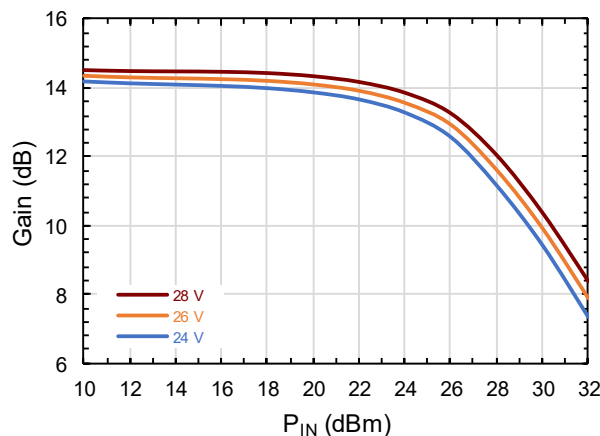
Drain Current vs. V_{DS} and P_{IN}



Gate Current vs. V_{DS} and P_{IN}



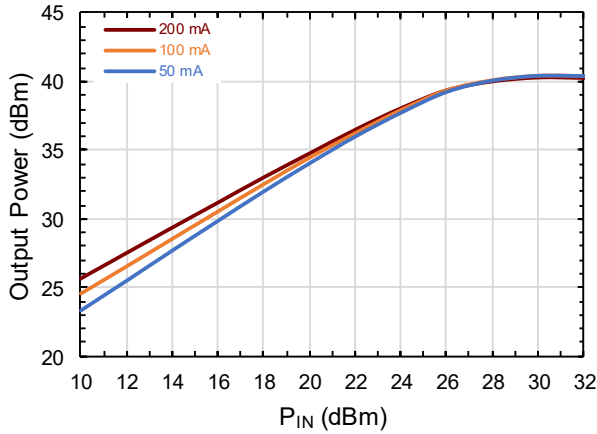
Large Signal Gain vs. V_{DS} and P_{IN}



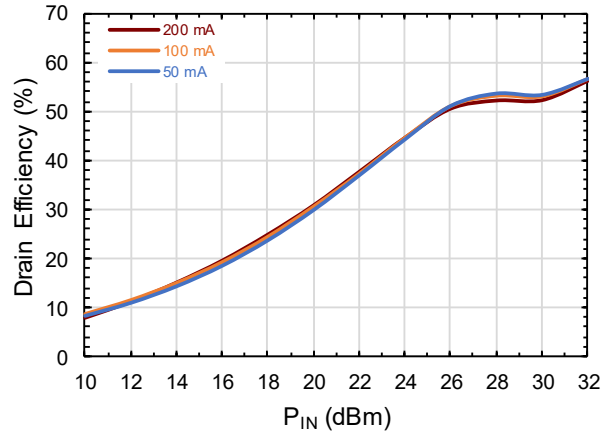
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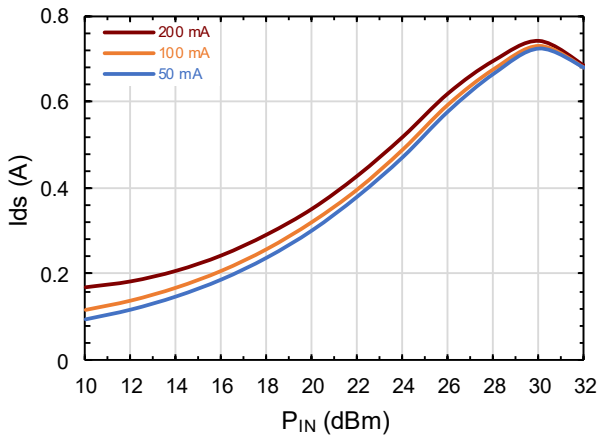
Output Power vs. I_{DQ} and P_{IN}



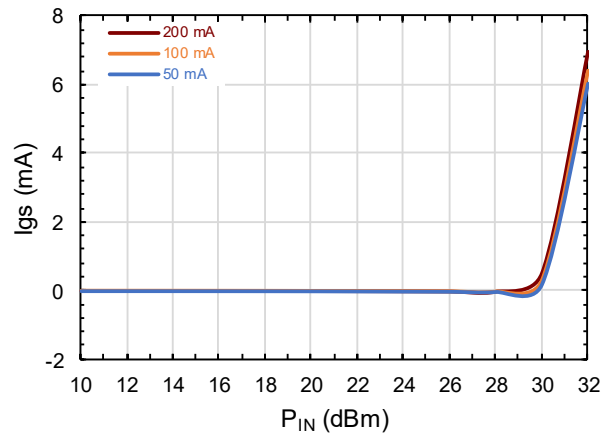
Drain Efficiency vs. I_{DQ} and P_{IN}



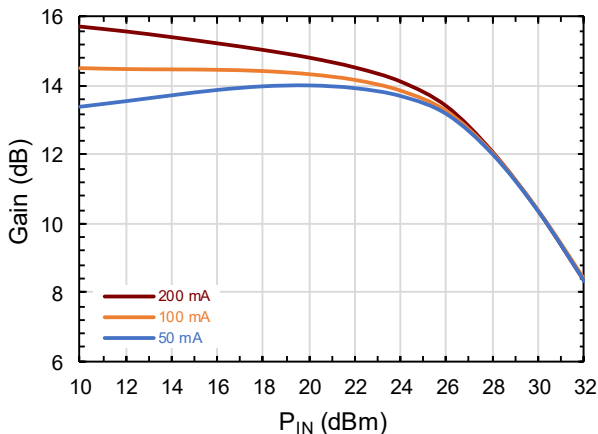
Drain Current vs. I_{DQ} and P_{IN}



Gate Current vs. I_{DQ} and P_{IN}



Large Signal Gain vs. I_{DQ} and P_{IN}

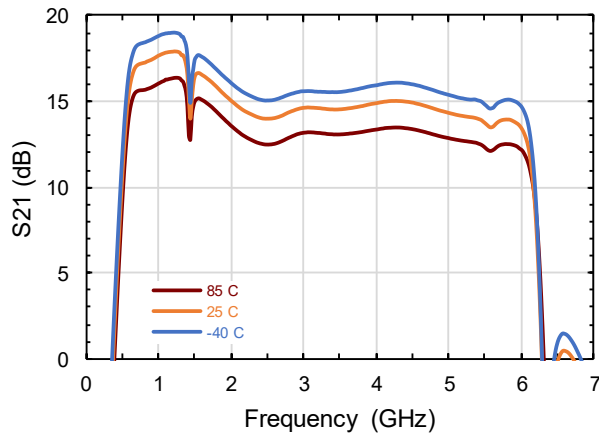


Typical Performance Curves as Measured in the 2 - 6 GHz Evaluation Test Fixture:

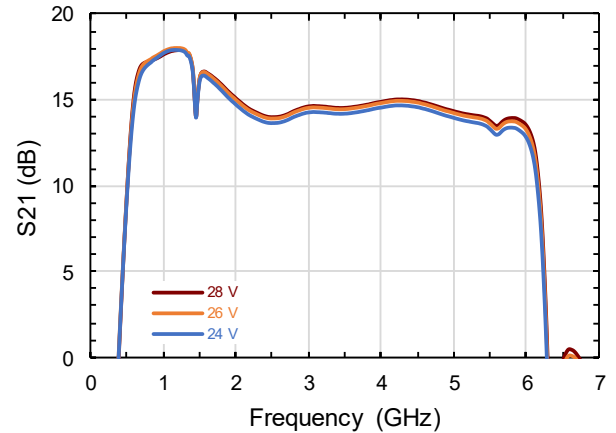
CW, $V_{DS} = 28$ V, $I_{DQ} = 100$ mA, $P_{IN} = -20$ dBm (Unless Otherwise Noted)

For Engineering Evaluation Only—This data does not Modify MACOM's Datasheet Limits.

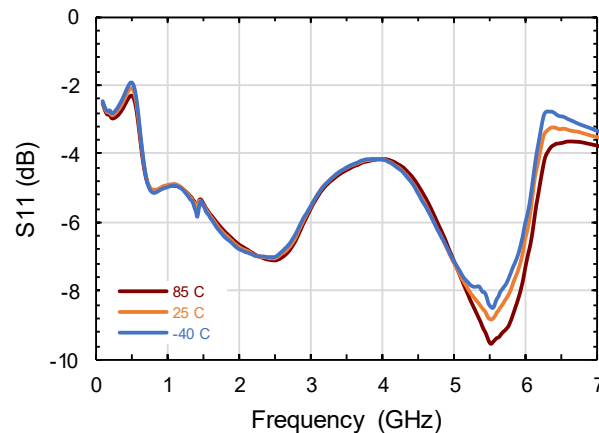
S21 vs Frequency and Temperature



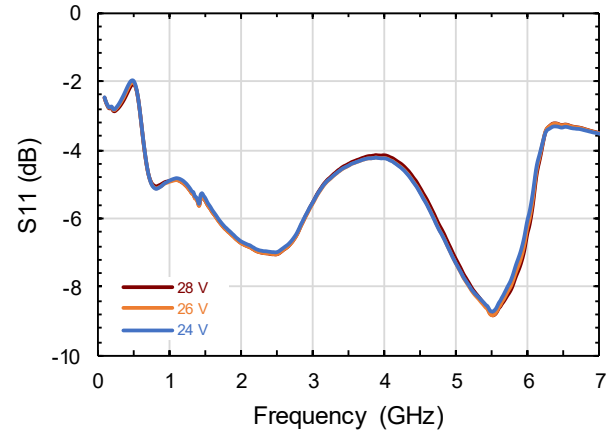
S21 vs Frequency and V_{DS}



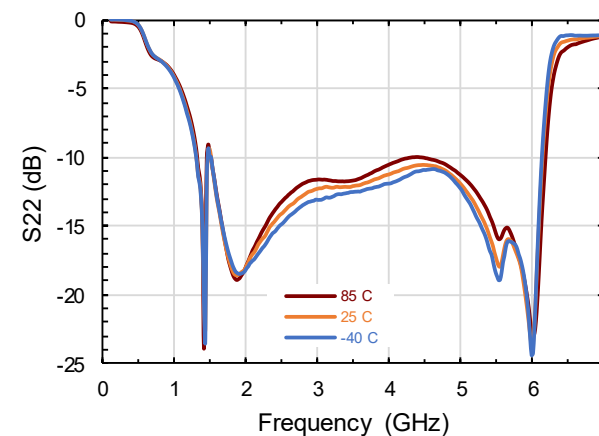
S11 vs Frequency and Temperature



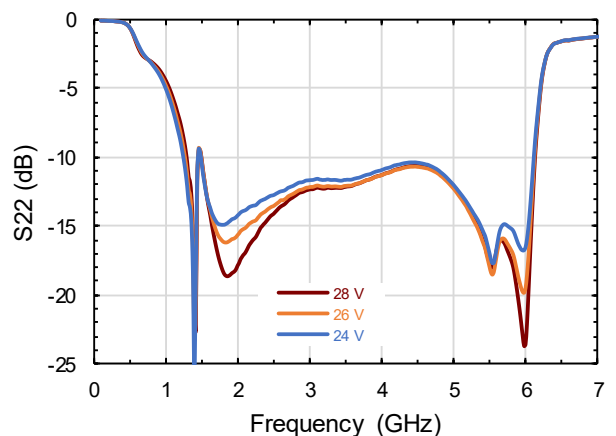
S11 vs Frequency and V_{DS}



S22 vs Frequency and Temperature



S22 vs Frequency and V_{DS}

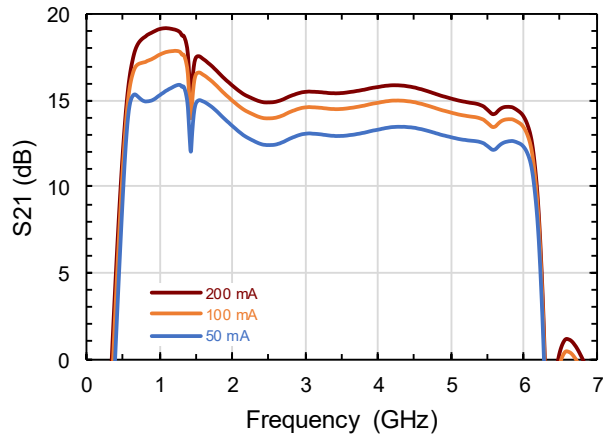


Typical Performance Curves as Measured in the 2 - 6 GHz Evaluation Test Fixture:

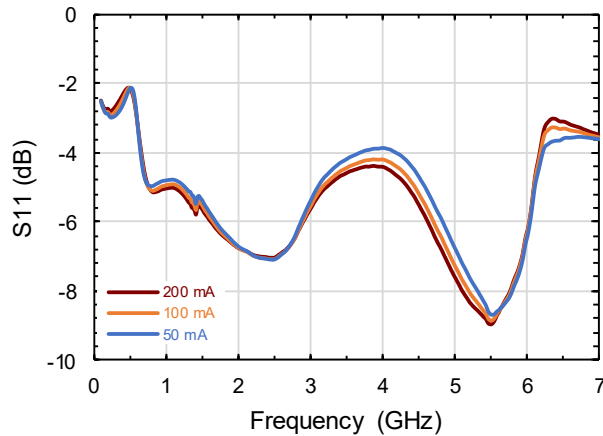
CW, $V_{DS} = 28\text{ V}$, $I_{DQ} = 100\text{ mA}$, $P_{IN} = -20\text{ dBm}$ (Unless Otherwise Noted)

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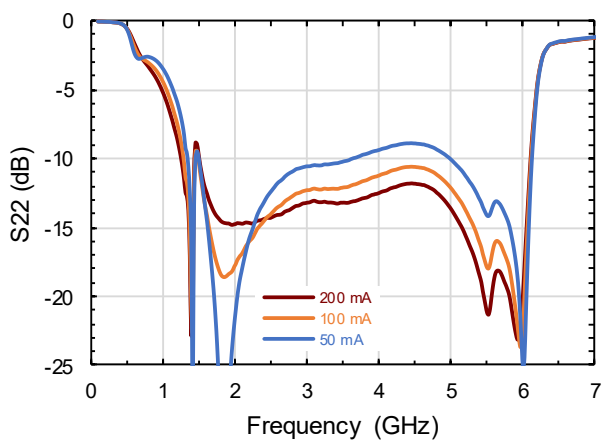
S21 vs Frequency and I_{DQ}



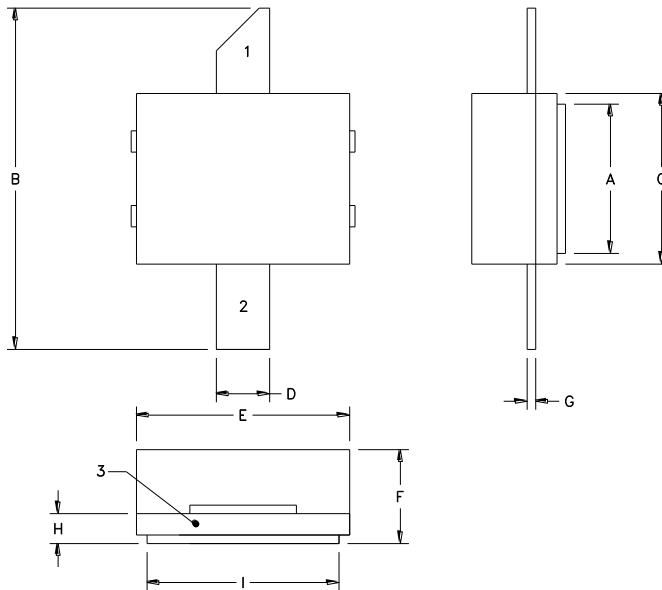
S11 vs Frequency and I_{DQ}



S22 vs Frequency and I_{DQ}



Lead-free 440109 Package Dimensions



NOTES: (UNLESS OTHERWISE SPECIFIED)

1. INTERPRET DRAWING IN ACCORDANCE WITH ANSI Y14.5M-1982 DIMENSIONING AND TOLERANCING.
2. CONTROLLING DIMENSION: INCH.
3. ALL PLATED SURFACES ARE Ni/Au

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.135	.145	3.43	3.68
B	.315	.325	8.00	8.26
C	.155	.165	3.94	4.19
D	.045	.055	1.14	1.40
E	.195	.205	4.95	5.21
F	.085	.104	2.15	2.65
G	.007	.009	.178	0.23
H	.026	.030	.660	.762
I	.175	.185	4.45	4.70

- PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE

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